

# 3. Trade-Offs and Cost-Benefit Analysis of Considered Solutions

Having in mind the outline of O-ESD functional blocks, here are summarized various trade-offs and cost-benefit analysis of considered technical solutions [1]. This analysis is based on technical specifications available from publicly available data from the manufacturers and the estimated prices from online sources. The estimated prices for components are compiled from four online distributors of electronic components during the period July–October 2024 and should be taken into account only as relative indicators. The prices can change due to market fluctuations and the actual prices are actually higher due to VAT and possibly other fees. The distributors used as a reference are

- (1) https://www.digikey.com/,
- (2) https://eu.mouser.com/,
- (3) https://export.farnell.com/ and
- (4) https://www.tme.eu.

# 3.1. Power Supply

The considered power supplies are presented in [1]. Based on those data, one or two Li-Ion 3.7 V batteries in the form factor 18650 seem to be the most promising choice because they are widely available, they have one of the highest energy densities and are reasonably priced. Furthermore, separate chargers for those batteries are readily available on the market. Estimated price of Li-Ion 3.7 V 18650 battery of capacity 2600 mAh is 7 EUR, while the charger (for two batteries simultaneously) is priced 13 EUR.

In order to estimate the battery powered O-ESD, the following is assumed. A capacitor of 150 pF charged up to 30 kV stores about 75 mJ of energy. This is the highest energy of a single ESD pulse that O-ESD should produce. One 3.7 V battery of capacity 2600 mAh is theoretically able to provide energy for several hundreds of thousands of (highest considered) ESD pulses. However, in practice the battery will power the whole O-ESD, including microcontroller, LCD and switch control. If we assume that the microcontroller consumes approximately 300 mW, that LCD consumes approximately 500 mW and that the control of switch is negligible due to very short periods when it needs to be closed (approximately 1 µs), a single 3.7 V battery of capacity 2600 mAh should be able to provide energy for O-ESD for approximately 12 hrs, and sustain one 30 kV ESD pulse every second. In practice, due to conversion losses and efficiency that can not be ideal, a rough estimate is that battery-powered O-ESD should be able to run for several hours on a single 3.7 V battery of capacity 2600 mAh.

### 3.2. User Interface

Having in mind the stated roles for the user interface, LCD screen seems to be necessary [1]. The choice of LCD is coupled with the selection of controllers and is therefore discussed together with microcontrollers. The choices for other equipment for the user interface, like switches, tasters, etc. depend significantly on fundamental choices for O-ESD that must be done in the first place. Therefore, the choices for other equipment of the user interface will be done at a later stage.

## 3.3. Controller

Multiple microcontrollers have been considered due to the fact that the controller should orchestrate, observe and synchronize all the functionalities of O-ESD, as well as to provide human-readable information on LCD and handle I/O user requests.

However, for all considered microcontrollers the information about ESD immunity is either scarce or missing. Therefore, before making the final decisions for O-ESD, those controllers must pass basic ESD tests and their robustness for working in ESD harsh environment must be understood and enhanced if needed. Therefore, the following data mainly concerns the hardware, pinouts, software environment and LCD options.

The first considered family of microcontrollers is Arduino [2]. These microcontrollers are released under the open license for both hardware and software. The programming is done in integrated and freely available Arduino IDE. There is a library for working with a variety of LCDs [3]. The considered Arduino microcontrollers are listed in Table I. The fact that both hardware and software for Arduino family are open, puts this microcontroller in the first line for consideration for O-ESD.



Table I. Considered Arduino microcontrollers.

DEVELOPMENT BOARD		CONTROLLER	DIGITAL I/O PINS	ANALOG INPUT PINS	ANALOG OUTPUT PINS	PWM PINS	PRICE [EUR]
Arduino UNO R3	AT	mega328P	-				
	Clock [MHz]	ADC					
	16	6-ch. 10-bit	14	6	0	6	25–30
Arduino MICRO	АТ	mega32u4					
COLUMN   C	Clock [MHz]	ADC					
GENERAL GENERA	16	12-ch. 10-bit	20	12	0	7	25–30
Arduino NANO	AT	mega328P					
(RINII) 464	Clock [MHz]	ADC					
CHARLE   C	16	6-ch. 10-bit	20	8	0	6	25–30



DEVELOPMENT BOARD	MICRO	CONTRO	LLER	DIGITAL I/O PINS	ANALOG INPUT PINS	ANALOG OUTPUT PINS	PWM PINS	PRICE [EUR]
Arduino NANO EVERY	AT	mega4809	)					
(2000) Market 1/20/2 and 10 10 10 10 10 10 10 10 10 10 10 10 10	Clock [MHz]		ADC	22	0	0	5	12–15
Column   C	16	16-0	ch. 10-bit	22	8	U	3	12–13
Arduino MEGA 2560	AT	mega2560	)					
	Clock [MHz]		ADC					
	16	ADC  ADC  16-ch. 10-bit  16-ch. 10-bit  54  16-ch. 10-bit  54  ADC  54  ADC  ADC  ADC  ADC  ADC  ADC  ADC  AD		16	0	15	40–45	
	ATS	AMD21G	18					
Arduino MKR ZERO			2bit low power					
1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1	Clock [MHz]	ADC	DAC	8	7	1	13	30–35
	48	14-ch. 12-bit	1-ch. 10-bit 350 ksps					



DEVELOPMENT BOARD	MICRO	CONTRO	LLER	DIGITAL I/O PINS	ANALOG INPUT PINS	ANALOG OUTPUT PINS	PWM PINS	PRICE [EUR]
Arduino DUE		P1SAM3X8  ® Cortex®						
	Clock [MHz]	ADC	DAC					
	84	14-ch. 12-bit 1 Msps	2-ch. 12-bit 1 Msps	54	12	2	12	45–50
Arduino LEONARDO	AT	mega32U	4					
100 100 100 100 100 100 100 100 100 100	Clock [MHz]	ADC	DAC				_	
Company   Comp	16	14-ch. 12-bit 1 Msps	N/A	20	12		7	25–30



DEVELOPMENT BOARD	MICRO	CONTRO	LLER	DIGITAL I/O PINS	ANALOG INPUT PINS	ANALOG OUTPUT PINS	PWM PINS	PRICE [EUR]
Arduino ZERO	SAMD21 Cortex®-M0+ 32bit low power ARM MCU							
ATTOCHASSIONS  POSS STATUS LED  POSS FOREY  PASS TO LED  POSS TO LED	Clock [MHz]	ADC	DAC					
(457) (MX) (85 (175 CHR) (	48	14-ch. 12-bit	1-ch. 10-bit	20	6	1	10	45–50
Arduino PORTENTA H7	STM32H747 Cortex®-M							
LL-Po 3.7 V USB Type-C C THE 1900 BMA J1-44 C TYPE 1900 BMA J1-44	Clock [MHz]	ADC	DAC					
MIS	240 & 480	8-ch. 16-bit	2-ch. 12-bit	78	8	1	10	80



The second considered family comprises MSP microcontrollers. Two classes of those controllers MSP430 and MSPM0 (Arm® Cortex ®-M0) seem to be possible solutions for O-ESD and they are listed in Tables II and III, respectively. The programming for MSP controllers is done in Code Composer Studio (CCS) using C/C++ programming language [4]. The software from version v7 is free of charge. CCS is based on the Eclipse open-source software framework. There is no license fee associated with Code Composer Studio. Users are free to download and install Code Composer Studio without having to purchase a license. For MSP430 and Cortex M based MCUs a TI proprietary compiler and GCC are provided. Hardware is proprietary. There is a library for controlling LCDs [5] and [6].

Table II. Considered MSP430 microcontrollers.

DEVELOPMENT BOARD	M	IICROCONTRO	OLLER	PINS ON BOARD	ANALOG INPUT PINS	ANALOG OUTPUT PINS	PWM PINS	PRICE [EUR]
MSP430FR2433  BooterPux Sandard MSP-EXP435FR433 BooterPux Sandard MSP-EXP435FR433 BooterPux Sandard	Clock [MHz]	ADC	DAC	20	3	_	1	10–15
	16	8-ch. 10-bit 200 ksps	-	20	7		•	10 13
MSP430FR2355	Clock [MHz]	ADC	DAC					
	24	12-ch. 12-bit 200 ksps	Two enhanced comparator with integrated 6-bit DAC as reference voltage.	40	12	-	-	15–20



DEVELOPMENT BOARD	М	ICROCONTROL	LER	PINS ON BOARD	ANALOG INPUT PINS	ANALOG OUTPUT PINS	PWM PINS	PRICE [EUR]
MSP430FR6989	Clock [MHz]	ADC	DAC					
	16	16-ch. 12-bit	N/A	40	10	N/A	5	25–30
MSP430FR5529	Clock [MHz]	ADC	DAC					
(1) Denote an interrupt capable (1)  Software Configuration  (2) Denote an interrupt capable (1)  Software Configuration  (3) Software Configuration  (4) Software Configuration  (5) Software Configuration  (6) Software Configuration  (7) Denote an interrupt capable (1)  Software Configuration  (8) Software Configuration  (9) Software Configuration  (1) Denote Configuration  (1) Denote Configuration  (2) Software Configuration  (3) Software Configuration  (4) Software Configuration  (5) Software Configuration  (6) Software Configuration  (7) Denote Configuration  (8) Software Configuration  (9) Software Configuration  (1) Software Configuration  (1) Software Configuration  (2) Software Configuration  (3) Software Configuration  (4) Software Configuration  (5) Software Configuration  (6) Software Configuration  (7) Software Configuration  (8) Software Configuration  (9) Software Configuration  (1) Software Configuration  (1) Software Configuration  (2) Software Configuration  (3) Software Configuration  (4) Software Configuration  (5) Software Configuration  (6) Software Configuration  (7) Software Configuration  (8) Software Configuration  (9) Software Configuration  (1) Software Configuration  (1) Software Configuration  (1) Software Configuration  (2) Software Configuration  (3) Software Configuration  (4) Software Configuration  (5) Software Configuration  (6) Software Configuration  (7) Software Configuration  (9) Software Configuration  (1) Software Configuration  (2) Software Configuration  (3) Software Configuration  (4) Software Configuration  (5) Software Configuration  (6) Software Configuration  (7) Software Configuration  (8) Software Configuration  (9) Software Configuration  (1) Software Configuration  (1) Software Configur	25	16-ch. 12-bit 200 ksps	N/A	40	8	N/A	5	15



DEVELOPMENT BOARD	М	ICROCONTRO	LLER	PINS ON BOARD	ANALOG INPUT PINS	ANALOG OUTPUT PINS	PWM PINS	PRICE [EUR]
MSP430FR2311	Clock [MHz]	ADC	DAC					
Control Park standard   MSP-EXP400FR2311 Pin map   Control Park standard   C	16	8-ch. 10-bit	One enhanced comparator with integrated	20	2	N/A	N/A	15–20
MSP-EXP430FR2311 Pin map	16	200 ksps	6-bit DAC as reference voltage				PINS	
MSP430FR4133	Clock [MHz]	ADC	DAC					
NOT-ACTION TO THE TOP OF THE PROPERTY OF THE P	16	10-ch. 10-bit 200 ksps	N/A	20	2	N/A	1	15–20



DEVELOPMENT BOARD	М	ICROCONTRO	LLER	PINS ON BOARD	ANALOG INPUT PINS	ANALOG OUTPUT PINS	PWM PINS	PRICE [EUR]
MSP430FR5969	Clock [MHz]	ADC	DAC					
BoosterPack  MSP-EXP430FR6669 Pin Map  MSP-EXP430FR6669 Pin Map  BoosterPack Standard  MSP-EXP430FR6669 Pin Map  BoosterPack Standard	16	16-ch. 12-bit 200 ksps	N/A	20	2	N/A	1	20–25
13								
MSP430FR2476	Clock [MHz]	ADC	DAC					
2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2	16	12-ch. 12-bit 200 ksps	One enhanced comparator with integrated 6-bit DAC as reference voltage	40	8	N/A	N/A	15–20
MSP430FR5994  Booken-Pack Blacked MSP-EXPLODERSON Pin map MSP-EXPLODERSON Pin map Booken-Pack standard	Clock [MHz]	ADC	DAC					
MET EXT ANT FEM (COLD )  MET EXT ANT FEM (COLD	16	16-ch. 12-bit	N/A	40	8	N/A	5	20–25



Table III. Considered MSPM0 microcontrollers.

DEVELOPMENT BOARD	MI	CROCONTROI	LLER	PINS ON BOARD	ANALOG INPUT PINS	ANALOG OUTPUT PINS	PWM PINS	PRICE [EUR]
MSPMOL1306    Principles are not connected to the LacroPhil to connecting default.   **Connection to LacroPhil to Connecting to default.   **Connection to LacroPhil to Connecting to default.   **Connecting to Connecting to Con	Clock [MHz]	ADC	DAC					
	32	1-ch. 12-bit 1 Msps	One high- speed comparator with built-in reference DAC.	40	5	•	6	20–25
MSPM0G3507	Clock [MHz]	ADC	DAC					
1	80	2-ch. 12-bit 4 Msps	12-bit 1 Msps	40	9	1	7	20–25
MSPM0C1104	Clock [MHz]	ADC	DAC					
	24	10-ch. 12-bit 866 ksps	N/A	20	9	-	?	10



The third considered family of solutions for O-ESD controller is Raspberry Pi [7], listed in Table IV. The programming for Raspberry Pi can be done either in C/C++ or MicroPython. MicroPython is written in C99 and the entire MicroPython core is available for general use under the MIT license. Most libraries and extension modules (some of which are from third parties) are also available under MIT or similar licenses. One can freely use and adapt MicroPython for personal use, in education, and in commercial products. MicroPython source code is available on the GitHub page, and its website <a href="https://micropython.org/download/">https://micropython.org/download/</a>. The Raspberry Pi operates in the open-source ecosystem: it runs Linux (a variety of distributions), and its main supported operating system, Pi OS, is open source and runs a suite of open-source software. The Raspberry Pi Foundation contributes to the Linux kernel and it releases much of its own software as open source. The Raspberry Pi's schematics are regularly released as documentation, but the board is not open hardware. Raspberry Pi has multiple options for controlling LCDs and monitors [8], most of which are too complex or too expensive for the O-ESD.

Table IV. Considered Raspberry PIs.

DEVELOPMENT BOARD		CROCONTROL	,	GPIO	ANALOG INPUT PINS	ANALOG OUTPUT PINS	PRICE [EUR]
RASPBERRY PI PICO	Al	RM® Cortex®-M	10+				
	Clock [MHz]	ADC	DAC				
Company   Comp	133	12-bit 500 ksps	N/A	23	3	N/A	5–10
RASPBERRY PI PICO 2		Dual Cortex-M3	3				
	Clock [MHz]	ADC	DAC				
The state of the s	150	12-bit 500 ksps	N/A	23	3	N/A	5–10



The fourth family of considered microcontrollers is STM32 [9]. The programming is done in STM32Cube IDE using C/C++ programming language. Software STM32Cube IDE provides a free, open-source development platform. The hardware is proprietary. There are multiple options for graphic interface [10]. The considered STM32 microcontrollers are listed in Table V. The fact that some of the considered STM32 controllers have Arduino-matching pinouts, makes those microcontrollers interchangeable between these two considered families, which would be a nice possibility for O-ESD.

Table V. Considered STM32 microcontrollers.

DEVELOPMENT BOARD	MIC	CROCONTROL	LER	GPIO	ANALOG INPUT PINS	ANALOG OUTPUT PINS	PRICE [EUR]
	A	Arm® Cortex®-M	14				
STM32F3DISCOVERY	Clock [MHz]	ADC	DAC	37	1	6	15–20
	72	4 Select. 12/10/8/6 bits	2-ch, 12- bit				
STM32F3348-DISCO	Α	Arm® Cortex®-M	14				
lite. augmented DISCO-534C8	Clock [MHz]	ADC	DAC				
	72	15-ch Select. 12/10/8/6 bits	3-ch, 12- bit	37	1	6	15–20



DEVELOPMENT BOARD	MIC	CROCONTROL	LER	GPIO	ANALOG INPUT PINS	ANALOG OUTPUT PINS	PRICE [EUR]
NUCLEO-F031K6*	Al	RM® Cortex®-M	10+				
ille ougmented Nucleo F031K6	Clock [MHz]	ADC	DAC				
TOTAL MANUAL TOTAL MANUAL MANU	48	10-ch, 12-bit	N/A	20	8	N/A	10–15
NUCLEO-F042K6*	Al	RM® Cortex®-M	10+				
Ille.ougmented NUCKO-P94X6	Clock [MHz]	ADC	DAC				
	48	10-ch, 12-bit	N/A	20	8	N/A	10–15



DEVELOPMENT BOARD	MICROCONTROLLER			GPIO	ANALOG INPUT PINS	ANALOG OUTPUT PINS	PRICE [EUR]
NUCLEO-F303K8*	ARM® Cortex®-M4						
Illin augmented NICLIC-FBINA	Clock [MHz]	ADC	DAC	20			10–15
	72	9-ch, 12-bit	3-ch, 12- bit		8	3	
	ARM® Cortex®-M0+						
NUCLEO-L011K4*	Clock [MHz]	ADC	DAC				
NUCLO-BLIM  NUCLO-	32	10-ch, 12-bit	N/A	20	8	N/A	10–15



DEVELOPMENT BOARD	MICROCONTROLLER			GPIO	ANALOG INPUT PINS	ANALOG OUTPUT PINS	PRICE [EUR]
NUCLEO-L031K6*	ARM® Cortex®-M0+						
its out writed words units	Clock [MHz]	ADC	DAC				
	32	10-ch, 12-bit	N/A	20	8	N/A	10–15
NUCLEO-L432KC*	Α	RM® Cortex®-N	Л4				
Mile ougmented MUCLEO-443KC	Clock [MHz]	ADC	DAC				
NOCIO-LADRE  NOCIO	80	10-ch, 12-bit	N/A	20	8	N/A	10–15

<sup>\*</sup>With Arduino-Nano-compatible headers.



Considered LCDs are with logic voltages from 3 V to 5 V with two to four rows of characters. The prices of such LCDs are in the range from 15 EUR to 70 EUR. Several examples of considered LCDs are listed in Table VI.

Table VI. Considered LCD displays.

Table VI. Considered LCD displays.							
Model	Voltage [V]	Characters (columns x lines)	Interface type	Module size	Price [EUR]		
MIDAS DISPLAYS MC42005A6WR-SPTLY-V2	3	20 x 4	Parallel	98 mm x 60 mm	25		
MIDAS DISPLAYS MC21605L6W-SPTLY  5MM CHRACTERS 2X16 MIDAS LCDS	5	16 x 2	Parallel	69 mm x 29 mm	15		
NHD-0420H1Z-FL-GBW-33V3  Welcome to Newhaven Please Enter User ID >usera01_ LOGIN[ ] LOGOUT[*]	3.1–3.6	20 x 4	Parallel	79 mm x 36 mm x 13 mm	15		
LCM-S02004DSF	5	20 x 4	Parallel	98.00 mm x 60.00 mm x 12.70 mm	35		
LCM-S04004DSF	5	40 x 4	Parallel	190.00 mm x 54.00 mm x 14.50 mm	70		

Alphanumeric displays up to 20 columns x 4 lines seem to be sufficient for O-ESD and can communicate with practically all considered microcontrollers. Displays with 40 columns x 4 lines seem to be physically too large for O-ESD.



# 3.4. High-voltage Generator

Five approaches have been considered for the design of high-voltage generator [1]: (1) Marx generator, (2) resonance energy transfer, along with three solutions with cascade for voltage multiplication excited by (3) flyback converter, (4) push-pull circuit and (5) audio amplifier.

#### 3.4.1. Marx Generator

Marx generator does not seem to be a feasible solution for O-ESD due to the need for spark gaps that are hard to control in the air. Namely, the spark formation is dependent on the distance between gap ends, the air temperature, the air pressure, etc. On the other hand, spark gaps with pressurized gas have only fixed breakdown voltages.

### 3.4.2. Resonance Energy Transfer

The solution for O-ESD based on resonance energy transfer is a simple one. There are only a few elements if this approach is used for O-ESD and no high-voltage cascade is required.

However, this solution is expensive as it requires a vacuum relay (in addition to the relay for firing the ESD gun). The output voltage is limited by the relay to 15 kV, and such relays are of limited availability. Practically all its elements (the transformer, the relay, and the rectifier) must be able to handle high voltages. Single-shot mode of operation is preferred to save the relay life.

The output voltage can be controlled by adjusting the DC source voltage (which would require a voltage stabilizer) or by adjusting the closed switch time.

Example of bill-of-materials is:

- Vacuum Reed relay, 15 kV (1 pc, estimated price: 120 EUR)
- Transformer (ETD 49/25/16 core with accessories; several layers of 0.1 mm wire with thick paper insulation between adjacent layers; large air gap, estimated price: 10 EUR + wire)
- Resistor (e.g., 1 Ω) to limit the current; high power required because the peak current is 1–2 A, (1 pc, estimated price: 16 EUR) and
- BY8 diodes, 2 pcs, connected in series to withstand 15 kV (estimated price: 5 EUR).

The estimated price of the high-voltage generator based on resonance energy transfer is around 150 EUR: hence it might be a feasible solution for O-ESD. However, the control of the level of its output voltage might need additional circuitry. Experimental work is needed to make the final decision about resonance energy transfer in the context of O-ESD.

#### 3.4.3. Cascade for Voltage Multiplication

The considered cascade for voltage multiplication is based on a ladder network of capacitors and diodes [1]. In theory, arbitrarily high voltages can be achieved at the output of such cascade, if a specified number of capacitors and diodes is used. The estimated price of a capacitor of 1 nF that works up to 4 kV (DC) is approximately 1 EUR, while the price of high-voltage diodes is up to 3 EUR. Hence, a cascade with several dozens of capacitors and diodes should cost about 120 EUR and should be able to provide controllable high voltages needed for O-ESD.

However, the simulation results show that the limiting factor for cascades is inverse leakage current of diodes. If capacitors of small capacitances are used in the cascade, they charge quickly by the generator, but also discharge quickly through real diodes. Large capacitors slowly discharge through real diodes, but the build-up of the output voltage is slow, too. We considered both single and double cascades. Illustrative examples of single and double cascades are shown in Figs. 1 and 2, respectively.

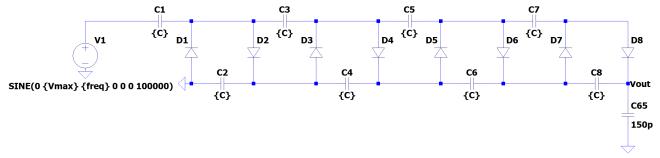


Figure 1. An example of single cascade for voltage multiplication.



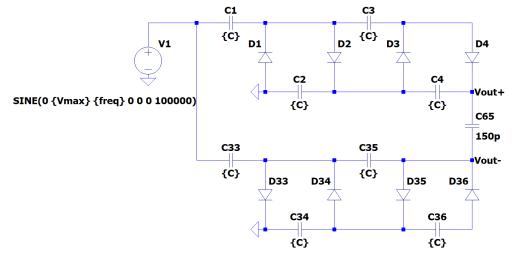


Figure 2. An example of double cascade for voltage multiplication.

The typical results for a cascade with 100 pF capacitors for the maximal output voltage, the total time to reach 50 % of its maximal voltage and the total time to reach 90 % of its maximal voltage, as functions of the total number of used capacitors (and diodes) are shown in Figs. 3, 4 and 5, respectively. The cascade is excited with AC voltage of frequency 20 kHz and of amplitudes 500 V, 1 kV, 1.5 kV and 2 kV. From Fig. 3 it can be seen that for a single cascade with 15–20 capacitors (of 100 pF) no increase in output voltage can be achieved with large numbers of capacitors. Hence, such cascades have practical limits for their output voltage.

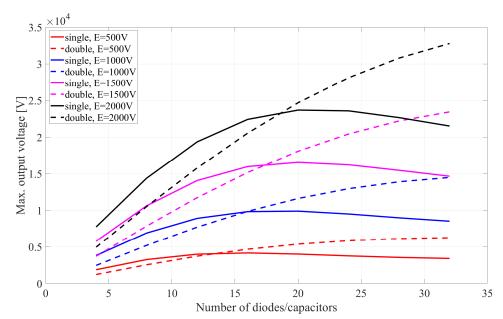


Figure 3. Maximal output voltage of cascades with 100 pF capacitors.



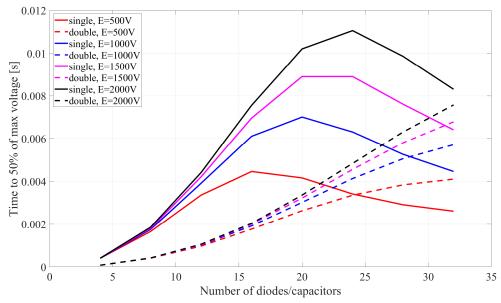


Figure 4. Time to reach 50 % of maximal output voltage of cascades with 100 pF capacitors.

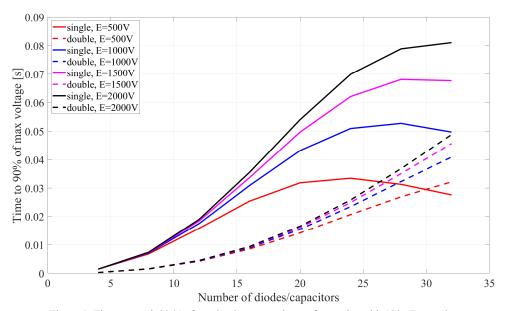


Figure 5. Time to reach 90 % of maximal output voltage of cascades with 100 pF capacitors.

The typical results for cascade with 1 nF capacitors, for the maximal output voltage, the total time to reach 50 % of its maximal voltage and the total time to reach 90 % of its maximal voltage, as functions of the total number of used capacitors (and diodes), are shown in Figs. 6, 7 and 8, respectively. The cascade is excited with AC voltage of frequency at 20 kHz and amplitudes 500 V, 1 kV, 1.5 kV and 2 kV. From Figs 6–8 it can be seen that single cascades can provide a somewhat larger output voltage than double cascades. However, the time to reach 50 % and 90 % of the maximal output voltage is at least 3 times longer for single cascades than for double cascades. Therefore, double cascades with up to 32 capacitors of 1 nF seem to be feasible solutions for O-ESD.

In cases when a cascade is excited with flyback, push-pull or audio amplifier, at the input of the cascade there should be a transformer that can produce (and withstand) up to 2 kV at its secondary. Estimated price of such a transformer is from 5 EUR to 25 EUR (depending on the transformer) and it can be bought off-the-shelf. Alternatively, one has to make the transformer. These kinds of transformers are not widely available. One of the possible off-the-shelf solutions are current-sense transformers



7492540750 and 7492541000 made by Wurth company, with estimated price of 5 EUR. However, experimental testing is needed in order to cross-check their usability in O-ESD. The other option of making DIY high-voltage transformer must be experimentally cross-checked, too.

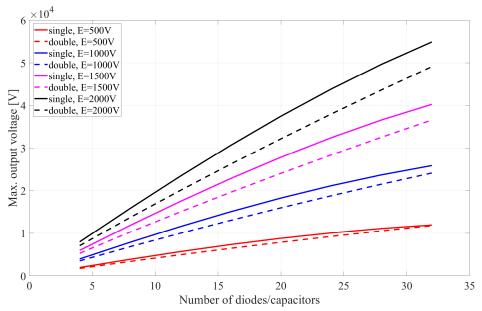


Figure 6. Maximal output voltage of cascades with 1 nF capacitors.

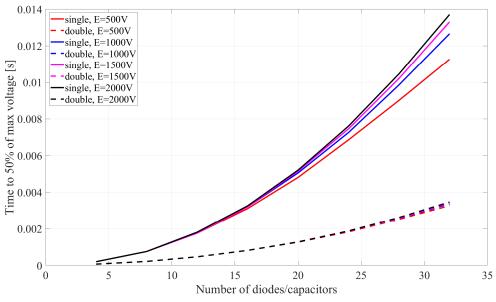


Figure 7. Time to reach 50 % of maximal output voltage of cascades with 1 nF capacitors.



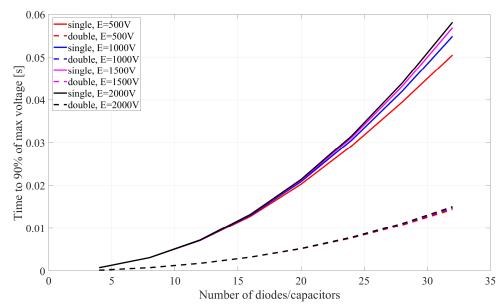


Figure 8. Time to reach 90 % of maximal output voltage of cascades with 1 nF capacitors.

#### 3.4.3.1. Flyback Converter

The simplest topology for excitation of the cascade for voltage multiplication, with a transformer, is by using a single transistor in flyback configuration. The transistor acts as a switch that is controlled by the microcontroller. Assuming that the output voltage of the microcontroller is large enough to turn on/off the transistor, only one resistor and one transistor are needed. Various (power) transistors can be used: bipolar NPN TIP122, bipolar NPN BD139, bipolar NPN MJE15032, MOSFET IRF640, MOSFET IRFZ44, etc.

Estimated price is around 10 EUR. Due to its simplicity and low price, this solution seems like the most promising one.

#### 3.4.3.2. Push-Pull Excitation

Another approach for excitation of the cascade for voltage multiplication with a transformer is by using two transistors in push-pull configuration. The transistors act as switches that are alternatively turned on/off and controlled by the microcontroller. Assuming that the output voltage of the microcontroller is large enough to turn on the transistor, two resistors and two transistors are needed. Various transistors can be used: bipolar NPN TIP122, bipolar NPN BD139, bipolar NPN MJE15032, MOSFET IRF640, MOSFET IRFZ44, etc.

Estimated price is around 20 EUR. While this approach is more complex than flyback, the potential benefit is that current through power supply (battery) is smoother than in the case of flyback, which might be beneficial for the overall usage of O-ESD. Therefore, it should be tested in practice.

#### 3.4.3.3. Audio System with Cascade for Voltage Multiplication

Single-channel amplifiers can be used. Also, two-channel amplifiers may be connected in bridge configuration (effectively, outputs are in series) or, possibly, in parallel, to increase the available output power. The amplifier chips usually require heatsinks. Classical packages seem to be obsolete, but they can conveniently be used with aluminum sinks. Modern packages are designed to be soldered to a huge copper surface, which requires a lot of PCB space.

The selected and considered audio amplifiers can handle frequencies up to around kHz, or even more, which is sufficient for O-ESD purposes. Due to the high output frequency, the capacitances of DC blocks can be significantly reduced compared with the standard audio amplifier. (The standard capacitances are listed in BoM.)



## (1) TDA2030 audio amplifier

While designated as obsolete on electronic equipment websites, it can still be found and is known to be robust. It has sufficient power for quick charging of cascade for voltage multiplication. It has one channel. The following elements are needed for complete assembly.

- TDA2030A audio amplifier
- 1N4001 diode, 2 pcs
- Resistor 1  $\Omega$ , 1 pc
- Resistor 4.7 k $\Omega$ , 1 pc
- Resistor 100 k $\Omega$ , 4 pcs
- Capacitor 2200 μF, 16 V, 1 pc
- Capacitor 220 μF, 16 V, 1 pc
- Capacitor 22 μF, 16 V, 1 pc
- Capacitor 2.2 μF, 16 V, 2 pcs
- Capacitor 0.1 μF, 2 pcs
- Clamp 2p, 1 pc
- Nylon connector male 2p, 2 pcs
- Nylon connector female 2p, 2 pcs
- Wires
- PCB
- Heat sink, 1 pc
- Screw M3x3, 1 pc.

The estimated price is 30 EUR.

### (2) PAM8406 audio amplifier

The available documentation seems insufficient for complete understanding of its characteristics. It belongs to the class D (digital) amplifier and has excellent efficiency. It has two channels. The following elements are needed for complete assembly.

- PAM8406DR audio amplifier, 1 pc
- Voltage stabilizer 78S05, 5 V, 2 A, 1 pc,
- Resistor 10 k $\Omega$  (SMD, 0805), 2 pcs,
- Capacitor 1 μF, 25 V (ceramic, SMD, 0805), 4 pcs,
- Capacitor 100 nF, 63 V (ceramic, SMD, 0805), 3 pcs,
- Capacitor 330 nF, 50 V (ceramic, SMD, 0805), 1 pc,
- Clamp 2p, 3 pcs,
- Nylon connector m 2p, 4 pcs,
- Nylon connector m 3p, 1 pc,
- Nylon connector f 2p, 5 pcs,
- Wires and
- PCB.

The total estimated price is 35 EUR.

### (3) LM4755 audio amplifier (stereo)

This is a standard two-channel audio amplifier. The following elements are needed for complete assembly.

- LM4755 audio amplifier
- BZX 5V1 diode, 1 pc
- Resistor 2.7  $\Omega$ , 2 pcs
- Resistor 12 kΩ, 3 pcs
- Capacitor 100 μF, 16 V, 4 pcs
- Capacitor 10 μF, 16 V, 1 pc
- Capacitor 0.1 μF, 4 pcs
- Clamp 2p, 2 pcs
- Nylon connector m 2p, 4 pcs
- Nylon connector f 2p, 4 pcs



- Wires and
- PCB (also as heat sink).

The total estimated price is 35 EUR.

## (4) LM4940/4950 audio amplifier (two channels)

This is another two-channel audio amplifier. The following elements are needed for complete assembly.

- LM4940 or LM4950 audio amplifier, 1 pc
- Resistor 10 kΩ, 2 pcs
- Resistor 20 kΩ, 2 pcs
- Resistor 100 kΩ, 2 pcs
- Capacitor 100 μF, 16 V, 2 pcs
- Capacitor 10 μF, 16 V, 2 pc
- Capacitor 0.39μF, 2 pcs
- Clamp 2p, 2 pcs
- Nylon connector m 2p, 4 pcs
- Nylon connector f 2p, 4 pcs
- Wires and
- PCB (also as heat sink).

The total estimated price is 35 EUR.

## (5) LM4940/4950 audio amplifier (bridge)

This is an audio amplifier in bridge configuration. The following elements are needed for complete assembly.

- LM4940 or LM4950 audio amplifier, 1 pc
- Resistor 10 kΩ, 1 pcs
- Resistor 20 kΩ, 5 pcs
- Resistor 100 kΩ, 1 pcs
- Capacitor 10 μF, 16 V, 2 pc
- Capacitor 0.39 μF, 1 pc
- Capacitor 33 pF, 1 pc
- Clamp 2p, 1 pc
- Nylon connector m 2p, 3 pcs
- Nylon connector f 2p, 3 pcs
- Wires and
- PCB (also as heat sink).

The total estimated price is 35 EUR.

In general, there are multiple solutions based on audio amplifiers. Such amplifiers are widely available and replacements are possible. The input for audio amplifier should be from microcontroller, as in two previous cases. The downside of the approach based on audio amplifier(s) is that about 10 additional components (resistors, capacitors, etc.) are needed.



## 3.5. Pulse Shaper

The number of elements for different considered pulse shapers is given in Table VII. All elements: capacitors, resistors and inductors should be of high quality and should be able to sustain voltages up to 15 kV (or 30 kV).

T-1-1- 1711	T1 4	- C		1	-1
Table VII.	Elements	OI	considered	buise	snapers.

Shaper topology	Resistors	Capacitors	Inductors	Total
#1	2	2	2	6
#2	3	3	3	9
#3	4	5	2	11
#4	4	4	2	10
#5	2	3	2	7
#6	3	5	2	10
#7	2	2	2	6

High-voltage capacitors and resistors of required values are not widely available on the market and the price is approximately 50 EUR per piece. The exact capacitances (or resistances) needed for the shaper are not the standard ones and the solutions might need several elements in parallel or series to reach the required values. Therefore, the topologies with the smallest number of elements will be considered for O-ESD – namely topologies #1 and #7.

Further, the 3D electromagnetic simulations show that the shaper might be printed on PCB for a fraction of the total price of a shaper made of discrete elements. In this approach only the resistors should be discrete and bought on the market. An example of such 3D model is shown in Fig. 9. Due to the possibility to significantly reduce the overall price and to reduce the dependence of the O-ESD solution on hard-to-find discrete elements, this approach will be experimentally tested.

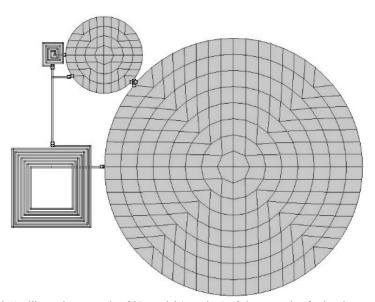


Figure 9. An illustrative example of 3D model (top view) of shaper made of printed components.

# 3.6. Output Switch

The output switch is one of the crucial and most expensive components of O-ESD. In general, only single-pole single-throw nominally-open (SPST-NO) switches are of interest for O-ESD. The only ones that can handle high voltages are reed relays with a vacuum. The switches listed in Table VIII are considered.



Table VIII. Considered switches (reed relays).								
Switch / Reed relay	Max. voltage [kV]	Rated current [A]	Coil voltage [V]	Coil current [mA]	Price [EUR]			
Sensata-Cynergy3 RELAY REED SPST-NO	10	2	5	313	80			
Sensata-Cynergy3 RELAY REED SPST-NO	10	2	12	126	90			
Standex-Meder Electronics RELAY REED SPST-NO	10	3	12	80	75			
MEDER electronic (Standex) Reed Relays SPST-NO	10	3	24	52	100			



Switch / Reed relay	Max. voltage [kV]	Rated current [A]	Coil voltage [V]	Coil current [mA]	Price [EUR]
Cynergy3 Reed Relays SPST-NO					
1	10	2	24	70	85
SENSATA / CYNERGY3	15	2	24	70	100
Pickering 60-1-A-5/3*	15	2	5	250	90
Pickering 60-1-A-24/3*	15	3	24	120	90

<sup>\*</sup>Pickering reed relays are available only through manufacturer website.

None of the considered reed relays can handle, by specification, switching voltages larger than 15 kV and the switching current is limited to up to 3 A. Both values are below the maximum values for voltage and current that O-ESD strives for. However, ESD pulse is of low energy and only by the experiment one can cross-check if considered reed relays can handle larger switching voltages and currents. There is a possibility that they can, because ratings specified by the manufacturer are given for significantly larger time intervals than that of ESD pulse. If the considered switches cannot handle larger voltages and currents than specified, then a custom reed relay/switch must be considered for O-ESD, or the O-ESD will be limited by the switch.

Furthermore, ESD lasts for about 200 ns, while the bouncing of contacts of considered reed relays is in the range of several milliseconds, which is several orders of magnitude larger. It is expected that bouncing of contacts will not limit the usability of considered switches in O-ESD. Measurements are needed in order to draw the final conclusion about the possibility of using those relays in O-ESD.

# 3.7. Mechanical Support

The trade-offs and cost-benefit analysis for mechanical support will be considered when all other functional blocks of the ESD generator are defined.



## References

- [1] <u>Functional Blocks of ESD Generator</u> (O-ESD-02)
- [2] https://www.arduino.cc/ (accessed 2024–09–01)
- [3] <a href="https://docs.arduino.cc/learn/electronics/lcd-displays/">https://docs.arduino.cc/learn/electronics/lcd-displays/</a> (accessed 2024–10–01)
- [4] https://software-dl.ti.com/ccs/esd/documents/users\_guide\_12.0.0/ccs\_overview.html (accessed 2024-08-01)
- [5] Design Considerations When Using MSP430 Graphics Library (accessed 2024–09–20)
- [6] MSPM0 Liquid Crystal Display (accessed 2024–09–25)
- [7] <a href="https://www.raspberrypi.com/">https://www.raspberrypi.com/</a> (accessed 2024–08–15)
- [8] <a href="https://www.raspberrypi.com/products/">https://www.raspberrypi.com/products/</a> (accessed 2024–08–20)
- [9] https://www.st.com/en/microcontrollers-microprocessors/stm32-32-bit-arm-cortex-mcus.html (accessed 2024–09–15)
- [10] Graphics with STM32 (accessed 2024–10–01)

#### **Revision history**

Version Date Author(s) Description 1.0 12/10/2024 D.O., A.Dj., J.D., D.N., A.K. Initial release.